

PCB terminal block - PTSM 0,5/ 3-2,5-H SMDBD1-S3R44 - 1702729

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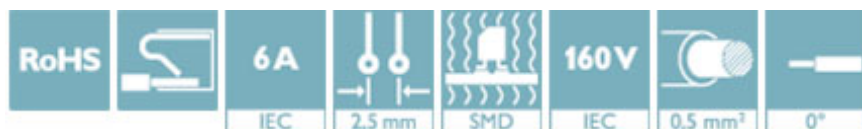


PCB terminal block, nominal current: 6 A, nom. voltage: 160 V, pitch: 2.5 mm, number of positions: 3, connection method: Push-in spring connection, mounting: SMD soldering, conductor/PCB connection direction: 0 °, color: black

The figure shows the 3-pos. version

Your advantages

- ✓ Time saving push-in connection, tools not required
- ✓ Defined contact force ensures that contact remains stable over the long term
- ✓ High current carrying capacity of 6 A in very compact dimensions
- ✓ Designed for integration into the SMT soldering process
- ✓ Additional solder anchors reduce the mechanical strain on the soldering spots



Key Commercial Data

Packing unit	770 pc
GTIN	 4 046356 609760
GTIN	4046356609760

Technical data

Item properties

Brief article description	PCB terminal block
Range of articles	PTSM 0,5/..-H-SMD
Pitch	2.5 mm
Number of positions	3
Connection method	Push-in spring connection
Mounting type	SMD soldering
Pin layout	Linear pad geometry
Number of levels	1

Electrical parameters

Rated current	6 A
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Technical data

Electrical parameters

Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV

Connection capacity

Conductor cross section solid	0.14 mm ² ... 0.5 mm ²
Conductor cross section flexible	0.2 mm ² ... 0.5 mm ²
Conductor cross section AWG / kcmil	26 ... 20
Conductor cross section flexible, with ferrule without plastic sleeve	0.25 mm ² ... 0.5 mm ²
Stripping length	6 mm

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/ JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	hot-dip tin-plated
Metal surface terminal point (top layer)	Tin (4 - 8 µm Sn)
Metal surface soldering area (top layer)	Tin (4 - 8 µm Sn)

Material data - housing

Insulating material	LCP
Insulating material group	IIIa
CTI according to IEC 60112	175
Flammability rating according to UL 94	V0

Dimensions for the product

Caption	Schematic representation – for additional information, see product range drawing in the Download Center
Length [L]	9 mm
Pitch	2.5 mm
Solder pin [P]	2 mm
Pin spacing	2.5 mm
Dimension a	5 mm

Dimensions for PCB design

Pin spacing	2.5 mm
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Packaging information

Type of packaging	packed in cardboard
Pieces per package	770
Denomination packing units	Pcs.

Ambient conditions

Ambient temperature (storage/transport)	-40 °C ... 70 °C
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C

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Technical data

Termination and connection method

Connection test	IEC 60998-2-2:2002-12
Test result	Test passed

Pull-out test

Pull-out test	IEC 60998-2-2:2002-12
	Test passed
Conductor cross section / conductor type / tensile force	0.14 mm ² / solid / > 7 N
	0.14 mm ² / flexible / > 7 N
	0.2 mm ² / solid / > 10 N
	0.5 mm ² / solid / > 30 N
	0.75 mm ² / flexible / > 35 N

Mechanical tests according to standard

Test specification	IEC 60998-2-2 (in parts)
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Electrical tests

Rated current	6 A
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV

Air clearances and creepage distances

Insulating material group	IIIa
Voltage	32 V
Rated insulation voltage (III/3)	32 V
Rated insulation voltage (III/2)	160 V
Rated insulation voltage (II/2)	160 V
Rated surge voltage (III/3)	2.5 kV
Rated surge voltage (III/2)	2.5 kV
Rated surge voltage (II/2)	2.5 kV

Current carrying capacity / derating curves

Specification	IEC 60998-2-2 (in parts)
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Vibration test

Resistance to ageing, to humidity conditions, to ingress of solid objects and to harmful ingress of water	Test passed IEC 60998-1:2002-12 168 h/100°C 48 h/30 °C/92 %
Test result	Test passed
Test specification	IEC 60998-1:2002-12
Dry heat	168 h/100°C
Humid heat	48 h/30 °C/92 %

Resistance to ageing, humidity and penetration of solids

Test result	Test passed
Test specification	IEC 60998-1:2002-12
Dry heat	168 h/100°C

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Technical data

Resistance to ageing, humidity and penetration of solids

Humid heat	48 h/30 °C/92 %
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Standards and Regulations

Connection in acc. with standard	EN-VDE
	UL

Environmental Product Compliance

China RoHS	Environmentally friendly use period: unlimited = EFUP-e
	No hazardous substances above threshold values

Approvals

Approvals

Approvals

UL Recognized / VDE Zeichengenehmigung / EAC / cULus Recognized

Ex Approvals

Approval details

UL Recognized		http://database.ul.com/cgi-bin/XYV/template/LISEXT/1FRAME/index.htm E118976-20130619
		B
Nominal voltage UN		150 V
Nominal current IN		5 A
mm²/AWG/kcmil		26-18

VDE Zeichengenehmigung		http://www2.vde.com/de/Institut/Online-Service/VDE-gepruefteProdukte/Seiten/Online-Suche.aspx	40048725
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EAC		B.01742
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Approvals

cULus Recognized  http://database.ul.com/cgi-bin/XYV/template/LISEXT/1FRAME/index.htm E60425-20030527	
	B
Nominal voltage UN	150 V
Nominal current IN	5 A
mm²/AWG/kcmil	26-20

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